# **APPROVAL**

PART NO.	DESCRITION	REMARKS
HT2203L	LCD MODULE (240 × RGB × 320 Dots)	This is ROHS compliant

CUSTOMER APPLICATION P/N	
APPROVED BY	
DATE	

PLEASE KINDLY FIND AND APPROVE THE SPECIFICATIONS INSERTED HEREIN AND RETURN ONE COPY HERE OF WITH YOUR SIGNATURE OF APPROVAL.

PERPARED BY	CHECKED BY	CONFIRMED BY



### HYES Optoelectronics, Inc.

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## **REVISION HISTORY**

Date	Rev. No.	Page	Summary
Feb. 19, 2008	-	ALL	- 1'st Issue

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## 1. Basic Specfications

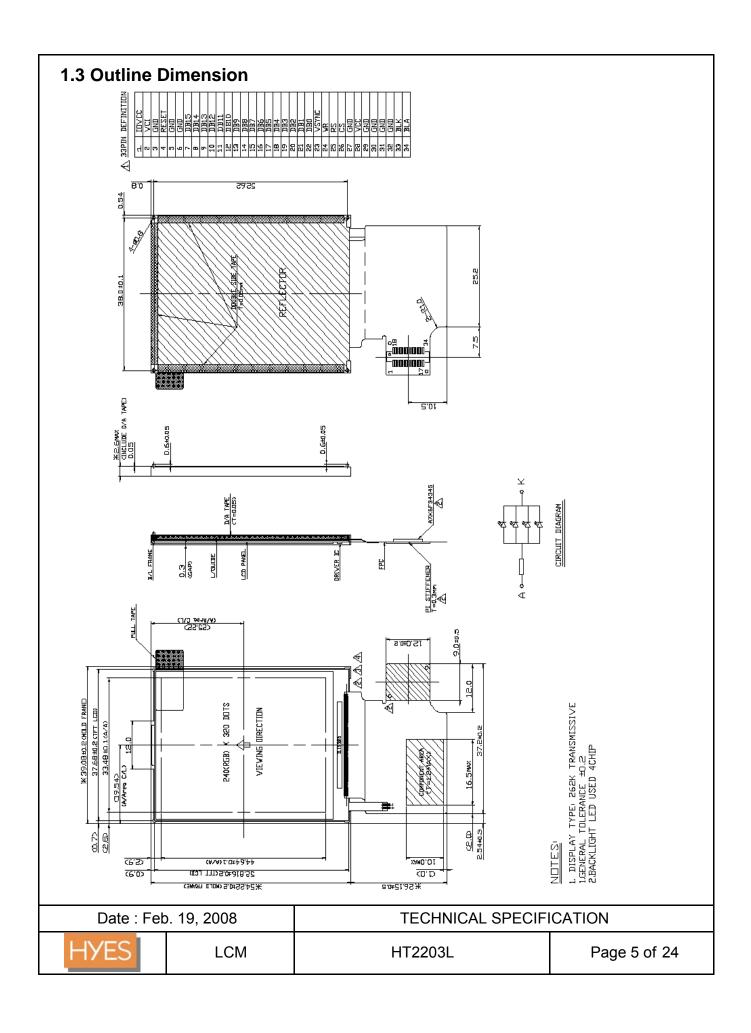
### 1.1 Display Specifications

in Biopiay operineations	•	
ltem	Description	Note
Resolution	240 × RGB × 320	
Display mode	TFT, Normally White, Transmissive	262K Color
Viewing direction	6 O'clock	
Driving method	720Ch-Source, 320Ch-Gate	
Backlighting	LED, White (4 chips in Parallell)	
Diver IC	ILI9320, COG	
Others	16-Bit, 80 Series	

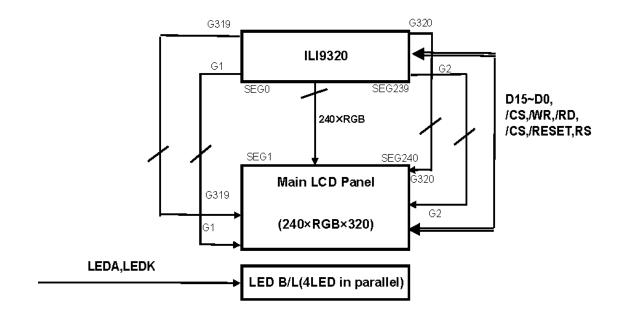
## 1.2 Mechanical Specifications

ltem	Specification	Unit
Module Size (W x H x T)	39.08 × 54.22 × 2.6	mm
Viewing Area (W × H)	-	mm
Active Area (W x H)	33.48 × 44.64	mm
Dot Size (W x H)	-	mm
Dot Pitch (W × H)	0.051 × 0.153	mm
Weight	About 10	g

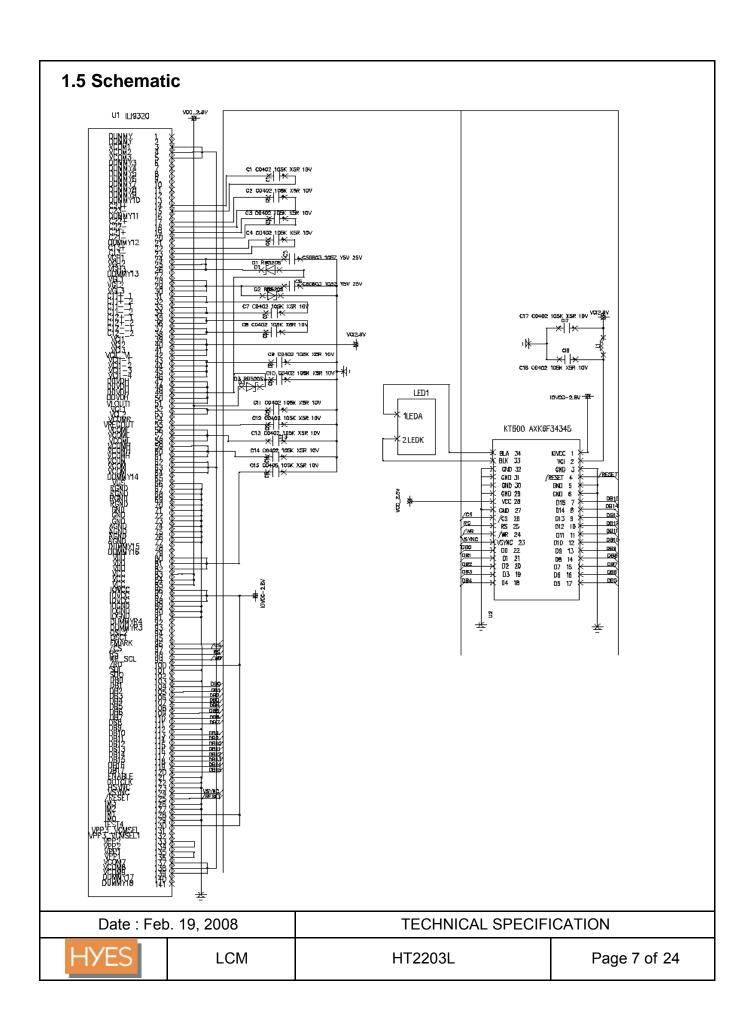
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## 1.4 Block Diagram



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### 2. Electrical Characteristics

### 2.1 Absolute Maximum Ratings

Item		Cymbol	Value			Unit	Condition	Remark
		Symbol	Min.	Тур.	Max	Oill	Condition	Remark
Supply	Logic	$V_{CC}$	- 0.3	-	4.6	٧	Ta =25℃	
Voltage Range	LCD	VGH	-0.3	-	18.5	٧	Ta =25℃	VRP-VRN
	LOD	VGL	-0.3	-	-18.5	٧	Ta =26 ℃	
Input Voltage		V <sub>IN</sub>	-0.3	-	VCC + 0.3	V	Ta =25℃	

### 2-2 Environmental Conditions

Item	Symbol	Symbol Min.		Unit
Operating temperature	Topr	-20	70	°C
Storage temperature	Tstg	-30	80	°C
Humidity (Ambient temperature=Ta)	Ta ≤ 60	°C	90% RH max	

### 2-3 DC Characteristics

Items		Sysbol		Spec. Value	Unit	Condition	
		Sysbol	MiN.	Тур.	Max.	Offic	Condition
	Logic	VCC	-	2.8	-	٧	
Operating voltage	GATE	VGH	12	-	18	٧	
		VGL	- 11	-	- 7	٧	
Supply our			-	-	15.0	mA	
Supply current		ICC					
High level		V <sub>IH</sub>	0.8 × IOV <sub>CC</sub>	-	IOV <sub>CC</sub>	V	-
Input voltage	Low level	V <sub>IL</sub>	-0.3	-	0.2 × V <sub>CC</sub>	V	-

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## 3. Optical Characteristics

Transmissive mode

(Ta = 25℃)

Ite	em	5	Symbol	Min.	Тур.	Max.	Unit	Condition	Note
\( \( \) \( \)		Θ2-θ1 Ø=0 (Y1-Y2)		50	60	-	Dog	Cr > 10	
Viewir	ıg	02-01	Ø=90 (X1-X2)	80	90	-	Deg	Cr > 10	
Contra	st ratio	Cr		150	250	-	-	$\Theta = 0$ $\emptyset = 0$	
Respon	se Time		Tr + Tf	-	25	-	ms	$\theta = 0$ $\emptyset = 0$	
CIE	R	(x,y)		0.58, 0.30	0.63, 0.34	0.68, 0.40			
Coordi	G	(x,y)		0.29, 0.55	0.33, 0.60	0.38, 0.65		θ = 0	
- nate	В		(x,y)	0.09, 0.03	0.14, 0.08	0.19, 0.13		Ø = 0	
	W	(x,y)		0.23, 0.25	0.28, 0.30	0.33, 0.35			
Brigh	Brightness L		L	150	220	-	cd/m2	18mA/LED	
Unifo	rmity			50	75	-			

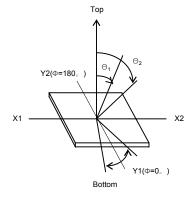
<sup>\*</sup>  $\emptyset$  = 0°,  $\emptyset$  = 90° means viewing direction.

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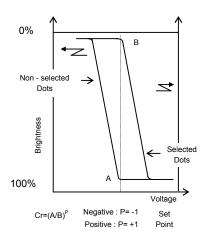
<sup>\*</sup> B/L is turned on.

<sup>\*</sup> Remark : as for contrast ratio, it is measured in panel only.

Note 1 . Definition of angle  $\Theta$  and  $\Phi$ 

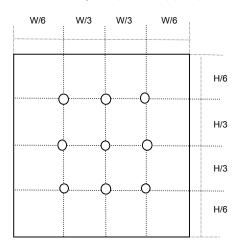


Note 3. Definition of contrast Cr

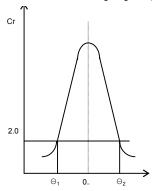


Lens Ø = 3mm

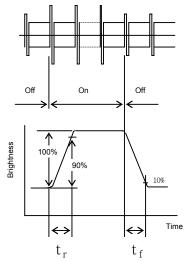
Note 5. Measuring Point(9 POINTS) (WxH)



Note 2. Definition of viewing angle  $\, \Theta_1$  and  $\, \Theta_2$ 



Note 4. Definition of Optical response



Rating is defined as the average brightness inside the viewing area

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## 4. Interface Pins

no	symbol	Description
1	IOVCC	IOVCC(1.8V/2.8V)
2	VCI	VCI(2.8V)
3	GND	GND
4	RESET	/Reset signal
5	GND	GND
6	GND	GND
7	DB15	Data Bit15
8	DB14	Data Bit14
9	DB13	Data Bit13
10	DB12	Data Bit12
11	DB11	Data Bit11
12	DB10	Data Bit10
13	DB9	Data Bit9
14	DB8	Data Bit8
15	DB7	Data Bit7
16	DB6	Data Bit6
17	DB5	Data Bit5
18	DB4	Data Bit4
19	DB3	Data Bit3
20	DB2	Data Bit2
21	DB1	Data Bit1
22	DB0	Data Bit0
23	VSYNC	Frame Synchronous Signal
24	WR	Write Enable Signal
25	RS	Data/Command Signal
26	/CS	Chip Select Signal
27	GND	GND
28	VCC	VCC(2.8V)
29	GND	GND
30	GND	GND
31	GND	GND
32	GND	GND
33	LEDA	LED Anode
34	LEDK	LED Cathode

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### 5. Backlight Specfication (LED Unit)

Item	Symbol	Spec. Value			Unit	Condition	
item	Symbol	Min.	Тур.	Max.	Oill	Condition	
Real Current	I <sub>LED</sub>	-	18	-	mA	note 1.	
Power dissipation	$P_{D}$	-	-	254	mW	note 2.	
Operation temp.	Topr		- 20 ~ 70	$^{\circ}$ C	-		
Storage temp.	Tstr		- 30 ~ 80	$^{\circ}$	-		

Note 1. B/L: 4EA LED in pARALLEL, the Maximum current is 20mA(full brightness)

Note2. Total power consumpation(max) depends on LED current/ LED driver efficiency, etc.

The above data only describes maximum power consumption of LCD's Chips.

(LED Max. Vf=3.4V, LED Max. Current=20mA)

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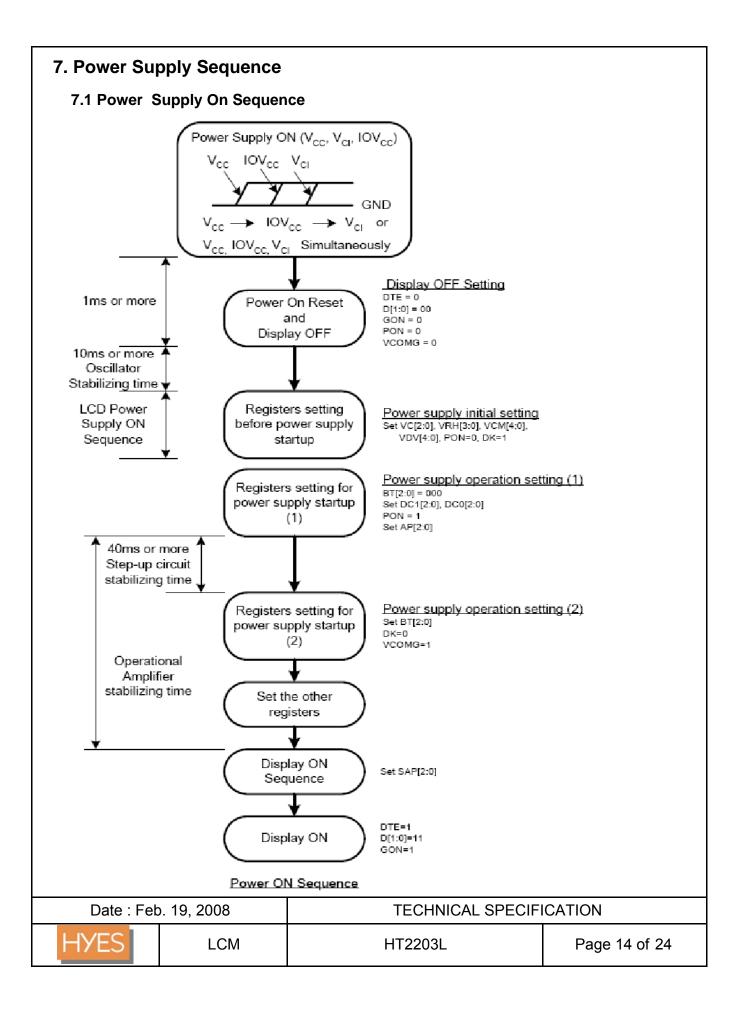
### 6. Recommended Software Setting Values (Initial code)

LDI:ILI9320

		Condition: \	/CC= 2.8V, 2007	.09.04
Step	Reg	Data	Delay	Command
1		RESET	30ms	
2	HE5	8000		
3	H00	0001		START OSC
4	H01	0100	40ms	SS=1,SM=0
5	H03	1030		BGR=1,I/D=11,AM=0,TRI=0,DFM=0
6	H04	0000		RCV=00,RCH=00,RSZ=00
7	H08	0202		FP=0010,BP=0010
8	H09	0000		PTS=000,PTG=00,ISC=0000
9	H0A	0000		FMARKOE=0,FMI=000
10	H0C	0000		ENC=000,RM=1,DM=00,RIM=00
11	H0D	0000		FMP=000000000
12	H0F	0001	40ms	VSLP=0,HSLP=0,DPL=0,EPL=0
13	H10	17B0		SAP=1,BT=0111,APE=1,AP=011
14	H11	0007		DC1=000,DC0=000,VC=111
15	H12	0119		VCMR=1,PON=1,VRH=1001
16	H13	1900		VDV=11001
17	H29	000C	30ms	VCM=01100
18	H30	0000		KP1=000,KP0=000
19	H31	0505		KP3=101,KP2=101
20	H32	0004		KP5=000,KP4=100
21	H35	0006		RP1=000,RP0=110
22	H36	0707		VRP1=00111,VRP0=00111
23	H37	0105		KN1=001,KN0=101
24	H38	0002		KN3=000,KN2=010
25	H39	0707		KN5=111,KN4=111
26	H3C	0704		RN1=111,RN0=100
27	H3D	0807		VRN1=01000,VRN0=00111
28	H50	0000		HAS=00000000
29	H51	00EF		HEA=11101111
30	H52	0000		VSA=000000000
31	H53	013F		VEA=100111111
32	H60	2700		GS=0,NL=100111,SCN=000000
33	H61	0001		NDL=0,VLE=0,REV=1
34	H6A	0000	20ms	VL8=000000000
35	H90	0010		DIVI=00,RTNI=10000
36	H92	0000		NOWI=000
37	H93	0003		MCPI=011
38	H95	0110		DIVE=01,RTNE=010000
39	H97	0000		NOWE=0000
40	H98	0000		MCPE=000
41	H07	0173		BASEE=1,GON=1,DTE=1,CL=0,D1=D
42				

NOTE: HYES requires the customer to follow the above instructions strictly. If customer would like to change the above instructions, the customer should inform HYES and get re-check from HYES, or the customer will be responsible for any unexpected result because of the change.

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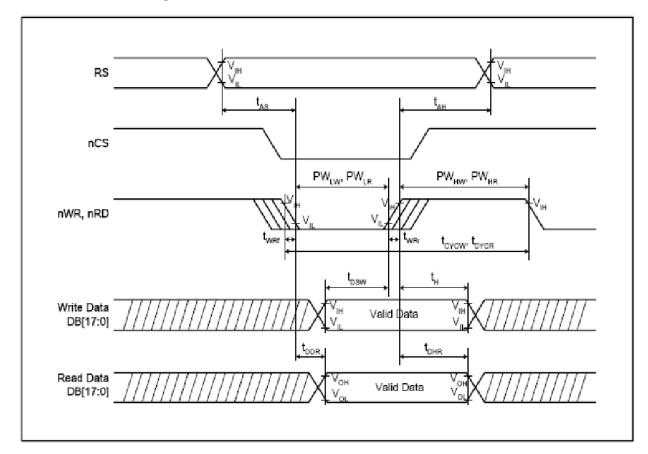
# 7.2 Off Sequence Display ON Setting DTE=1 D[1:0]=11 GON=1 Normal Display Display OFF Sequence Display OFF SAP[2:0] = 000Power Supply AP[2:0] = 000 PON = 0 Halt Setting VCOMG = 0 Power Supply OFF (V<sub>cc</sub>, V<sub>ci</sub>, IOV<sub>cc</sub>) y<sub>cı</sub> lov<sub>cc</sub> v<sub>cc</sub> $V_{\rm CI} \longrightarrow 10V_{\rm CC} \longrightarrow V_{\rm CC}$ or $V_{CC,} IOV_{CC,} V_{CI}$ Simultaneously

Power OFF Sequence

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### 8. Read/Write Timing characteristics (80 series MPU)

### **Read/Write Timing characteristics**



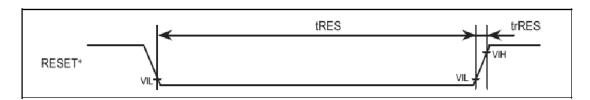
#### Normal Write Mode (IOVCC = 1.65~3.3V, VCC=2.4~3.3V)

	Item	Symbol	Unit	Min.	Тур.	Max.	Test Condition
Bus cycle time	Write	t <sub>eyew</sub>	ns	100	-	-	-
bus cycle time	Read	toyon	ns	300	-	-	-
Write low-level pu	lse width	PW <sub>LW</sub>	ns	50	-	500	-
Write high-level po	ulse width	PW <sub>HW</sub>	ns	50	-	-	-
Read low-level put	$PW_{LR}$	ns	150	-	-	-	
Read high-level po	PW <sub>HR</sub>	ns	150	-	-		
Write / Read rise /	fall time	twer/twer	ns	-	-	25	
Catus tima	Write ( RS to nCS, E/nWR )		ns	10	-	-	
Setup time	Read ( RS to nCS, RW/nRD )	tas		5	-	-	
Address hold time	<b>,</b>	t <sub>AH</sub>	ns	5	-	-	
Write data set up time		tosw	ns	10	-	-	
Write data hold time		t <sub>H</sub>	ns	15	-	-	
Read data delay ti	me	t <sub>DDR</sub>	ns	-	-	100	
Read data hold tin	ne	t <sub>DHR</sub>	ns	5	-	-	

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### **Reset Timing characteristics**

#### Reset Operation



Item	Symbol	Unit	Timing diagram	Min	Тур	Max
Reset low-level width	$t_{RES}$	ms	Figure 91	1	_	_
Reset rise time	$t_{fRES}$	μs	Figure 91	_	_	10

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#### 9. LCD Module Out-Going Quality Level

#### (1.0) Purpose

The LCD specification provides outgoing provision and its expected quality level based on our outgoing inspection of LCD.

#### (2.0) Applicable Scope

The LCD specification is applicable to the arrangement in regard to outgoing Inspection and quality assurance after it.

#### (3.0) Quality Specification

#### (3.1) Quality Level

The quality level of HYES are based on GB/T2828.1, Apply Level II,

normal inspection by single sampling.

Rank	Item	AQL	Note
Major(MA)	Segment Short, Missing	0.4	
	Solder Bridging, Cold Solder		
	Outside Dimension		
Minor (MI)	Black Spots, White Spots, Foreign Substance,	1.0	
	Pinhole, Segment Deformation, Scratchs(Glass & Pol.)		
	Air Bubbles between Glass & Polarizer,		
	Color Variation, Solder Ball, Misalignment		

Note) AQL- Acceptable Quality Level

#### (3.2) Appearance Standards

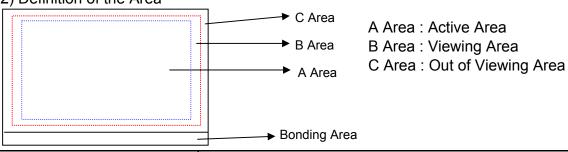
#### 1) Inspection Conditions

The LCD shall be inspected under 20W white fluorescent lamp light.

The distance between the eyes and the sample shall be 30cm.

All directions for inspecting the sample should be within 30° to perpendicular line.

#### 2) Definition of the Area



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No								
	Item			Criteri	a		Rank	Remark
1	Segment Short	Not allowe	d				MA	
	Segment Missing							
2	Solder Bridging		_	ı component			MA	
		<del></del>	except common circuit, is not allowed.					
3	Outside Dimension	_	Drawing & specification must be within					
			permitable tolerance.					
4	Cold Solder		Cold solder is not allowed.					
5	Black(White)	1) Round T	'ype				MI	
	Spots, Foreign							¥ 11
	Substances	1 1	ea		ble Q'ty	Remark		<b>*</b>
			nsion**	A Area	B Area			$  \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$
		≤ (			ore			V
		€ (		2	Ignore			
		€ (		1	Ignore			** : Mean
		0.3 <		0	Ignore			Diameter
								(X+Y)/2
		2) Liner Ty			11 05			
		I -	nsion		ble Q'ty	Remark		
		Length	Width	A Area	B Area			
		-	≤ 0.025		ore			
		≤ 2.5	≤ 0.05	3	Ignore			
		≤ 1.5	$\leq 0.075$ 0.075 <	2	Ignore ound type			
		At (1) & (		fect q'ty is n	nust not			
6	OC Spot						3 6 7	
		I —					MI	
		1 1	ea		ble Q'ty	Remark	MI	
		Dimer	nsion**	A Area	B Area	Remark	MI	
		Dime: ≪ (	nsion** ).2	A Area Ign	B Area ore	Remark	MI	
		Dimer ≤ 0	nsion** 0.2 0.8	A Area Ign	B Area ore Ignore	Remark	MI	
		Dime: ≪ (	nsion** 0.2 0.8	A Area Ign	B Area ore	Remark	MI	
7	A: D 11	Dimer ≤ 0	nsion** 0.2 0.8	A Area Ign	B Area ore Ignore	Remark		
7	Air Bubles	Dimer ≤ 0 ≤ 0	nsion** 0.2 0.8 1.0	A Area Ign 3	B Area ore Ignore Ignore		MI	
7	Between Glass &	Dimer S (	nsion** 0.2 0.8 1.0	A Area Ign 3 1	B Area core Ignore Ignore	Remark		
7	Between Glass & Polarizer	Dimer	nsion**  0.2  0.8  1.0  rea  nsion**	A Area  Ign 3 1  Accepta A Area	B Area Lore Ignore Ignore Idle Q'ty B Area			
7	Between Glass &	Dimer	nsion** 0.2 0.8 1.0 ea nsion** 0.15	A Area  Ign 3 1  Accepta A Area Ign	B Area core Ignore Ignore uble Q'ty B Area			
7	Between Glass & Polarizer	Dimer	nsion** 0.2 0.8 1.0 rea nsion** 0.15 0.3	A Area Ign 3 1 Accepta A Area Ign 3	B Area Lore Ignore Ignore  Ible Q'ty B Area Lore Ignore			
7	Between Glass & Polarizer	Dimer	nsion** 0.2 0.8 1.0 rea nsion** 0.15 0.3 0.5	A Area  Ign 3 1  Accepta A Area  Ign 3 2	B Area core Ignore Ignore  ble Q'ty B Area core Ignore Ignore			
7	Between Glass & Polarizer	Dimer	nsion**  0.2  0.8  1.0  rea nsion**  0.15  0.3  0.5  0.7	A Area  Ign 3 1  Accepta A Area  Ign 3 2 1	B Area core Ignore Ignore  ble Q'ty B Area core Ignore Ignore Ignore			
7	Between Glass & Polarizer	Dimer	nsion** 0.2 0.8 1.0 rea nsion** 0.15 0.3 0.5	A Area  Ign 3 1  Accepta A Area  Ign 3 2	B Area core Ignore Ignore  ble Q'ty B Area core Ignore Ignore			
7	Between Glass & Polarizer	Dimer	nsion**  0.2  0.8  1.0  rea nsion**  0.15  0.3  0.5  0.7	A Area  Ign 3 1  Accepta A Area  Ign 3 2 1 5	B Area core Ignore Ignore  ble Q'ty B Area core Ignore Ignore Ignore Ignore		MI	

### (3.3) Appearance Spec

No	Item	Criteria	Rank	Remark
8	Pin hole	$(X+Y)/2 \le 0.2 mm$	MI	
	(On Segment)	₩ithin 1 per one		
		segment (Less than 0.1mm		
		is not counted)		
		Total defects q'ty is must not exceed 5 pieces.		
9	Segment	, X , , , A	MI	(X + Y)/2
	Deformation	<b>├────┤→</b>		≤ 0.2mm
		$(X+Y)/2 \le 0.2 mn$		
		$\mathbb{Y} \qquad \qquad \mathbb{A} \leq 0.2 \text{mm}$		
		$B \le 0.2 \text{mm}$		
		(C-D) ≤ 0.2mm		
		<del>                                   </del>		
		Acceptable Q'ty		
		Dot, Segment 1		
		LCD 5		
		≤ 0.1 Ignore all defect		
		Each visible dot must be more than half		
		effective dot area		
10	Color Variation	Within the three colors, except LCD	MI	
		Standard color is acceptable.		
11	Glass & Polarizer	Follow NO.5(2) condition	MI	
	Scratch			
12	Solder Ball	1)Acceptable if the size of void is less	MI	
		than 0.18 mm		
		2)Acceptable if a solder ball is not movable		
		2)D-i		
		3)Rejectable if the solder ball exceed		
13	Miss Alignment	5EA in 2.54 × 2.54 mm area.  1)Acceptable if it dose not exceed 50% of		
13	MISS AIRSIDIEN	the lead width IC.		
		7 N/O - Dailed		
		W X > W/2: Reject		
		IC LEAD		
		2)Rejectable, provided that it does		
		exceed 50% of the component		
		termination width.		
		WM1		
		A A A A A A A A A A A A A A A A A A A		
		W1 > W2 : Reject		

Note : A limitation sample is given top priority

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### (3.3) Appearance Spec

No. Them	T	C: +:	_		D =1-	D1-
No Item 14 Touch Panel	1) Round Type \ Forei	Criteri on Substances			Rank MI	Remark
14 Touch Fanei	1) Round Types Totelgh Substances			1411	Y	
	Area	Accepta	ıble Q'ty	Remark		<del>   </del>
	Dimension**	A Area	B Area	TOMAK		I <del>\( \)</del> →
	≤ 0.1	Ign				[
	≤ 0.2	2	Ignore			
	≤ 0.3	1	Ignore			** : Mean
	0.3 <	0	Ignore			Diameter
						(X+Y)/2
	2) Liner Type & Scrato	h				
	Dimension	Accepta	ıble Q'ty	Remark		
	Length Width	A Area	B Area			
	- W≤0.025		ore			
	1 < 3.0	Ign				
	$\frac{1.0 < 1.0 }{3.0 < 1.0 }$ W $\leq 0.05$		2	Ignore		
	≤ 7 W≤0.1		l			
	- W>0.1	Follow ro	ound type			
	The area of the Newton It's NG. The area of the Newton It's OK.					
	b)None-regularity					
	The area of the Newton It's NG. The area of the Newton	_		_		
	It's OK.					

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### (4.0) Reliability Condition

Item	Content
Room Temperature Operation	50,000 hrs

### (4.1) Reliability Test - Module Middle Reliability

No.	Item	Condition	Test	Sample	Creteria	Note
			Time	Numbers	(Acc/Rej)	
1	High Temp	70 ± 2°C	120 hrs	3	0/1	
	Operation					
2	Low Temp	-20 ± 2℃	120 hrs	3	0/1	
	Operation					
3	High Humidity	00°C	120 hrs	3	0/1	
	Storage	90%rh				
4	Thermal	30mn stage -20 $℃$	100 cycles	3	0/1	
	Shock	↔70°C	/6days			

### (4.2) Criteria

- a. No changes for indication and appearance.
- b. Leave the all samples under roon temperature 4 hours after reliability test ends.

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#### **10. LCD Module Operation Instruction**

#### Part I. How to use the LCD Module

- 1. Don't hit the LCD Panel in any way because the LCD is made of glass.
- 2. Don't clean the surface of LCD with hard things. Please clean LCD with Air-gun or very soft cloth when necessary. The protective film on the POL can be removed just before assembly, otherwise, dust, spit or other foreign matter may attached on the LCD under the protective film. After the protective film is removed, only air-gun can be used to remove any dust or foreign matter. Fingure or cloth MUST NOT be used in such cases.
- 3. No chemical liquid is allowed to clean the LCD, such as alcohol, acetone and IPA. All of these candamage the LCD. Water on the LCD must be cleaned as soon as possible, for it will cause POL color change or other defect.
- 4. Please move and assemble LCD very carefully during assembly, and don't push or twist it.
- 5. Don't damage the FPC of LCD module. It will cause permanent defect.
- 6. Don't disassemble LCD module. It will cause permanent defect.
- 7. Don't expose LCD module under sunshine, strong fluorescence or ultraviolet radiation.
- 8. Please make sure that operators wear static-protective bands effectively and working tables are effectively earthing during operation.
- 9. Please place LCD module on the tray provided by HYES while moving it, in order to avoid mechanical damage. Hold the module's side frames to avoide damage during moving.
- 10. Don't twist, disassemble, squeeze or hit the PCB. It will damage the circuit or component on PCB and cause functional defect.
- 11. Please use the connector according to the instruction provided by HYES.
- 12. Please place dual module with the sub-panel upward. Trays should be placed in contrary direction. An empty tray should be placed on the top.
- 13. Sealing operation on PCB must be very careful to avoid short or cut the original circuit on PCB.Otherwise, it will cause permenant damage to the LCD.
- 14. Don't add direct DC or high voltage to LCD panel. It will cause functional damage to the LCD or shorten the life of LCD product.
- 15. LCD may respond slowly or display abnormally in extrem temperature (lower than -20℃ or higher than 50℃). But this doesn't mean LCD functional defect. LCD will display normally in regular temperature. Therefore, don't use LCD product in extrem temperature.

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- 16. Don't push the display area of LCD panel, it will cause abnormal display. This doesn't mean LCD functional defect, neither. LCD will display normally in regular temperature.
- 17. Electrical test of LCD product is made by using mobile phone provided by Customer. We can use special test equipment to do the test, also.
- 18. The black band on IC on LCD product is used to protect the IC from light. Please do NOT remove it.
- 19. Please take great care to use connector. Customer should be responsible for connector defect caused by operation on Customer side.

#### Part II Storage

- 1. Physical status of liquid crystal will change in extrem temperature, and it can not be resumed whenthe temperature returns to be normal. So LCD module should be stored in required temperature.
- 2. LCD module should be stored in required humidity. Low hymidity may add static, while high humidity may corrode the ITO circuit of LCD product. The suitable storage environment is: temperature:22±5°C, humidity: 55%±10%.
- 3. Don't expose LCD module under sunshine, strong fluorescence or ultraviolet radiation for a long time.lt should be stored in dark area.
- 4. LCD should be stored in static-protective polythene bag. Don't expose it in the air for a long time.

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